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#### 200 mA LOAD SWITCH FEATURING PRE-BIASED PNP TRANSISTOR AND N-MOSFE WITH GATE PULL DOWN RESISTOR

## **General Description**

LMN200B02 is best suited for applications where the load needs to be turned on and off using control circuits like micro-controllers, comparators etc. particularly at a point of load. It features a discrete pass transistor with stable V<sub>CE(SAT)</sub> which does not depend on the input voltage and can support continuous maximum current of 200 mA. It also contains a discrete N-MOSFET that can be used as control. This N-MOSFET also has a built-in pull down resistor at its gate. The component can be used as a part of a circuit or as a stand alone discrete device.

#### **Features**

- Voltage Controlled Small Signal Switch
- N-MOSFET with Gate Pull-Down Resistor
- Surface Mount Package
- Ideally Suited for Automated Assembly Processes
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

#### **Mechanical Data**

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 8
- Ordering Information: See Page 8
- Weight: 0.006 grams (approximate)

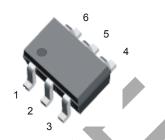


Fig. 1: SOT-363

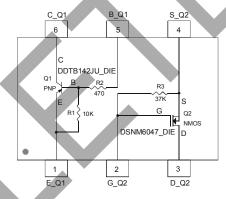


Fig. 2 Schematic and Pin Configuration

Sub-Component P/N	Reference	Device Type	R1 (NOM)	R2 (NOM)	R3 (NOM)	Figure
DDTB142JU_DIE	Q1	PNP Transistor	10K	470	_	2
DSNM6047_DIE (with Gate Pull-Down Resistor)	Q2	N-MOSFET	_	_	37K	2

#### **Maximum Ratings, Total Device** @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	$P_{D}$	200	mW
Power Derating Factor above 125°C	P <sub>der</sub>	1.6	mW/°C
Output Current	l <sub>out</sub>	200	mA

#### Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Operating and Storage Temperature Range	$T_{J}, T_{STG}$	-55 to +150	°C
Thermal Resistance, Junction to Ambient Air (Equivalent to One Heated Junction of PNP Transistor) (Note 3)	$R_{ heta}$ JA	625	°C/W

Notes:

- 1. No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.
- Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.



# **Maximum Ratings:**

Sub-Component Device: Pre-Biased PNP Transistor (Q1) @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-50	V
Supply Voltage	Vcc	-50	V
Input Voltage	V <sub>in</sub>	+5 to -6	V
Output Current	Ic	-200	mA

# Sub-Component Device: N-MOSFET With Gate Pull-Down Resistor (Q2)

@T<sub>A</sub> = 25°C unless otherwise specified

Charac	teristic	Symbol	Value	Unit
Drain-Source Voltage		V <sub>DSS</sub>	60	V
Drain Gate Voltage (R <sub>GS</sub> ≤1M Ohn	1)	$V_{DGR}$	60	V
Gate-Source Voltage	Continuous Pulsed (tp<50 uS)	V <sub>GSS</sub>	+/-20 +/-40	V
Drain Current (Page 1: Note 3)	Continuous (V <sub>gs</sub> = 10V) ulsed (tp <10 uS, Duty Cycle <1%)	ID	115 800	mA
Continuous Source Current		Is	115	mA





<b>Electrical Characteristics: Pre-B</b>	Electrical Characteristics: Pre-Biased PNP Transistor (Q1) @TA = 25°C unless otherwise specified							
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS	<u> </u>	l		l	l			
Collector-Base Cut Off Current	I <sub>CBO</sub>	_	_	-100	nA	$V_{CB} = -50V, I_{E} = 0$		
Collector-Emitter Cut Off Current	I <sub>CEO</sub>	_	_	-500	nA	V <sub>CE</sub> = -50V, I <sub>B</sub> = 0		
Emitter-Base Cut Off Current	I <sub>EBO</sub>	_	-0.5	-1	mA	$V_{EB} = -5V, I_{C} = 0$		
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-50	_	_	V	$I_C = -10 \text{ uA}, I_E = 0$		
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-50	_	_	V	$I_C = -2 \text{ mA}, I_B = 0$		
Input Off Voltage	V <sub>I(OFF)</sub>	_	-0.55	-0.3	V	$V_{CE} = -5V, I_{C} = -100uA$		
Output Voltage	V <sub>OH</sub>	-4.9	_	_	V	$V_{CC} = -5V, V_B = -0.05V,$ $R_L = 1K$		
Ouput Current (leakage current same as I <sub>CEO</sub> )	I <sub>O(OFF)</sub>	_	_	-500	nA	$V_{CC} = -50V, V_{I} = 0V$		
ON CHARACTERISTICS		•	•					
		_	_	-0.15	V	$I_C = -10 \text{ mA}, I_B = -0.5 \text{ mA}$		
		_	_	-0.2	V	$I_C = -50 \text{mA}, I_B = -5 \text{mA}$		
Collector-Emitter Saturation Voltage	V	_		-0.2	V	$I_C = -20$ mA, $I_B = -1$ mA		
Concetor-Emitter Cataration Voltage	V <sub>CE(SAT)</sub>	_		-0.25	V	$I_C = -100 \text{mA}, I_B = -10 \text{mA}$		
		_	<b></b>	-0.25	V	$I_C = -200 \text{mA}, I_B = -10 \text{mA}$		
		_		-0.3	V	I <sub>C</sub> = -200mA, I <sub>B</sub> = -20mA		
Equivalent On-Resistance*	R <sub>CE(SAT)</sub>	_		1.5	Ω	I <sub>C</sub> = -200mA, I <sub>B</sub> = -10mA		
		60	150		_	$V_{CE}$ = -5V, $I_{C}$ = -20 mA		
DC Current Gain	h	60	215		_	$V_{CE} = -5V, I_{C} = -50 \text{ mA}$		
De current Gain	h <sub>FE</sub>	60	245		_	$V_{CE}$ = -5V, $I_{C}$ = -100 mA		
		60	250	_	_	$V_{CE}$ = -5V, $I_{C}$ = -200 mA		
Input On Voltage	V <sub>I(ON)</sub>	-2.45	-0.7	_	V	$V_{O}$ = -0.3V, $I_{C}$ = -2 mA		
Output Voltage (equivalent to $V_{CE(SAT)}$ or $V_{O(ON)}$ )	V <sub>OL</sub>	-	-0.065	-0.15	V	$V_{CC}$ = -5V, $V_{B}$ = -2.5V, $I_{o}/I_{I}$ = -50mA /-2.5mA		
Input Current	li		-9	-28	mA	V <sub>I</sub> = -5V		
Base-Emitter Turn-on Voltage	V <sub>BE(ON)</sub>		-1.13	-1.3	V	$V_{CE} = -5V, I_{C} = 200mA$		
Base-Emitter Saturation Voltage	Various		-3.2	-3.6	V	$I_C = -50 \text{mA}, I_B = -5 \text{mA}$		
base-Emitter Saturation Voltage	V <sub>BE(SAT)</sub>	_	-4.6	-5.5	V	$I_C = -80 \text{mA}, I_B = -8 \text{mA}$		
Input Resistor (Base), +/- 30%	R2	_	0.47	_	KΩ	_		
Pull-up Resistor (Base to Vcc supply), +/- 30%	R1	_	10	_	KΩ	_		
Resistor Ratio (Input Resistor/Pull-up resistor) +/- 20%	R1/R2	_	21	_	_	_		
SMALL SIGNAL CHARACTERISTICS								
Transition Frequency (Gain Bandwidth Product)	f⊤	_	200	_	MHz	$V_{CE} = -10V, I_{E} = -5mA,$ f = 100MHz		
Collector Capacitance, (Ccbo-Output Capacitance)	C <sub>C</sub>	_	20	_	pF	V <sub>CB</sub> = -10V, I <sub>E</sub> = 0A, f = 1MHz		

<sup>\*</sup> Pulse Test: Pulse width, tp<300  $\mu$ S, Duty Cycle, d<=0.02



# **Electrical Characteristics:**

N-MOSFET with Gate Pull-Down Resistor (Q2) @T<sub>A</sub> = 25°C unless otherwise specified

h		1		ı	1	1		
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 4)				,				
Drain-Source Breakdown Voltage, BV <sub>DSS</sub>	V <sub>(BR)DSS</sub>	60	_	_	V	$V_{GS} = 0V, I_D = 10\mu A$		
Zero Gate Voltage Drain Current (Drain Leakage Current)	I <sub>DSS</sub>	-	_	1	μА	V <sub>GS</sub> =0V, V <sub>DS</sub> = 60V		
Gate-Body Leakage Current, Forward	I <sub>GSSF</sub>			0.95	mA	$V_{GS} = 20V, V_{DS} = 0V$		
Gate-Body Leakage Current, Reverse	I <sub>GSSR</sub>	_	_	-0.95	mA	$V_{GS} = -20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 4)								
Gate Source Threshold Voltage (Control Supply Voltage)	V <sub>GS(th)</sub>	1	1.9	2.2	V	$V_{DS} = V_{GS}, I_{D} = 0.25 \text{mA}$		
Statia Drain Sauras On State Valtage	\/	_	0.10	1.5	V	$V_{GS} = 5V, I_D = 50mA$		
Static Drain-Source On-State Voltage	$V_{DS(on)}$	_	0.15	3.75	V	V <sub>GS</sub> = 10V, I <sub>D</sub> = 115mA		
On-State Drain Current	I <sub>D(on)</sub>	500	_		mA	$V_{GS} = 10V$ , $V_{DS} \ge 2xV_{DS(ON)}$		
Static Dunin Source On Bosistanes	J	_	1.6	3		$V_{GS}$ = 5V, ID = 50mA		
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	_	1.4	2	Ω	V <sub>GS</sub> = 10V, ID = 500mA		
Forward Transconductance	_	80	240		mS	$V_{DS} \ge 2_X V_{DS(ON)}$ , $I_D = 115 \text{ mA}$		
Forward Transconductance	<b>g</b> FS	80	350		1110	$V_{DS} \ge 2_X V_{DS(ON)}$ , $I_D = 200 \text{ mA}$		
Gate Pull-Down Resistor, +/- 30%	R3	_	37		ΚΩ	_		
DYNAMIC CHARACTERISTICS								
Input Capacitance	C <sub>iss</sub>		_	50	pF			
Output Capacitance	Coss	_	_	25	pF	V <sub>DS</sub> = -25V, V <sub>GS</sub> = 0V, -f = 1MHz		
Reverse Transfer Capacitance	C <sub>rss</sub>	<b>- 7</b>		5	pF	-1 - 11VII 12		
SWITCHING CHARACTERISTICS								
Turn-On Delay Time	t <sub>D(on)</sub>	-		20	ns	V <sub>DD</sub> = 30V, V <sub>GS</sub> =10V,		
Turn-Off Delay Time	t <sub>D(off)</sub>	_		40	ns	$I_D$ = 200mA, $R_G$ = 25 Ohm, $R_L$ = 150 Ohm		
SOURCE-DRAIN (BODY) DIODE CHARACTERISTIC	S AND MAX	KIMUM RAT	INGS					
Drain-Source Diode Forward On-Voltage	$V_{SD}$		0.90	1.5	V	$V_{GS} = 0V, I_S = 115 \text{ mA}$		
Maximum Continuous Drain-Source Diode Forward Current (Reverse Drain Current)	<u>I</u> s			115	mA	_		
Maximum Pulsed Drain-Source Diode Forward Current	I <sub>SM</sub>			800	mA	_		

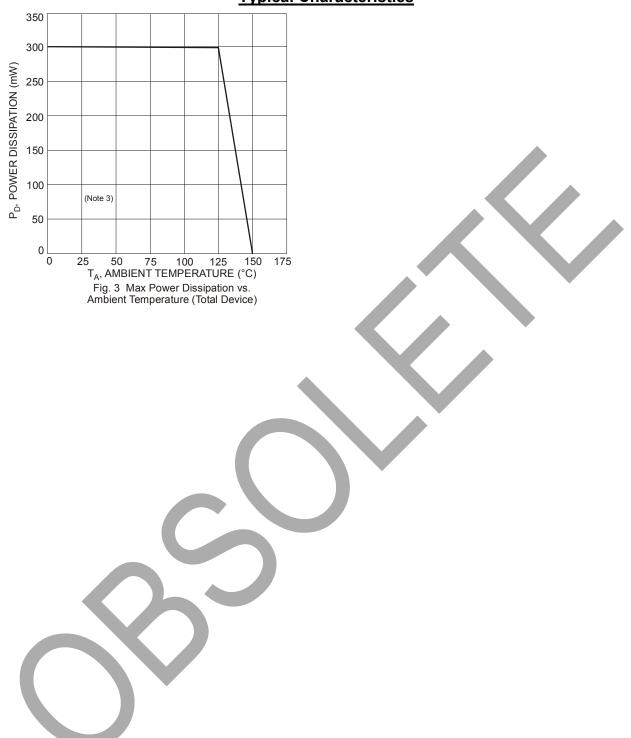
Notes: 4. Short duration pulse test used to minimize self-heating effect.



LMN200B02 Document number: DS30658 Rev. 8 - 4

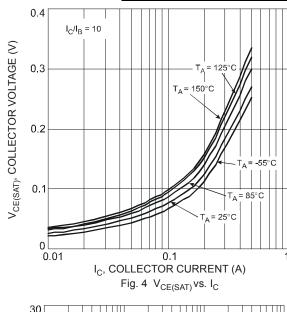


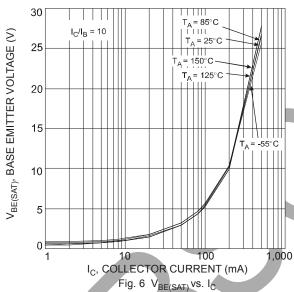
# **Typical Characteristics**

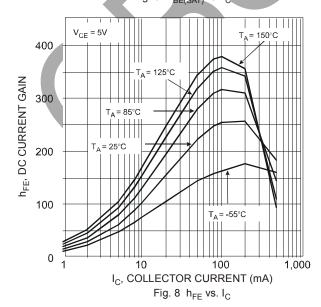


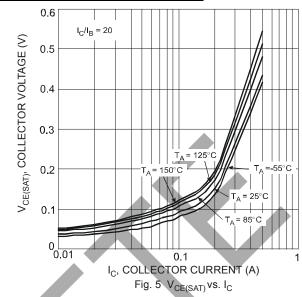


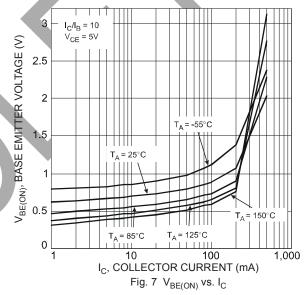
## **Typical Pre-Biased PNP Transistor (Q1) Characteristics**





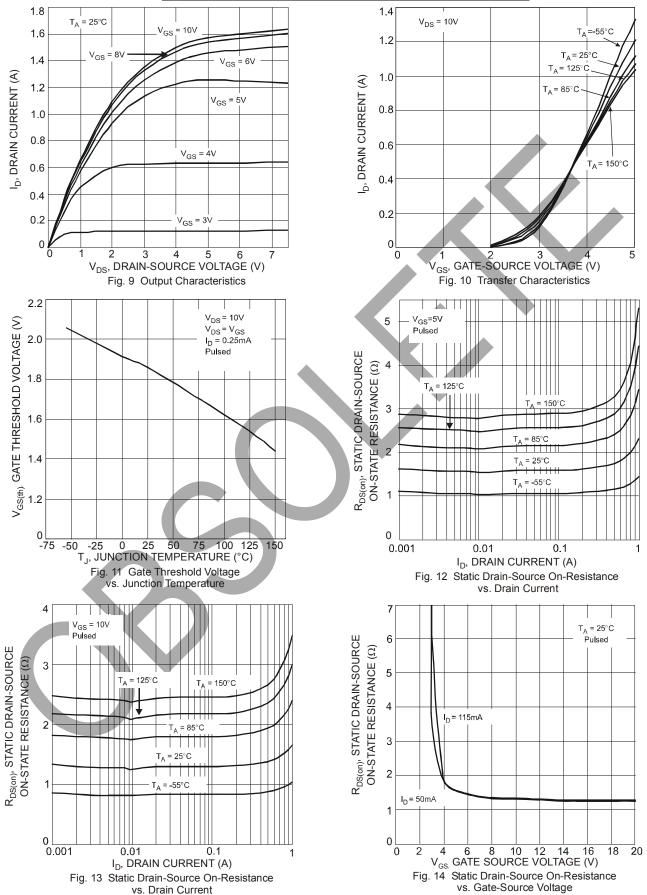




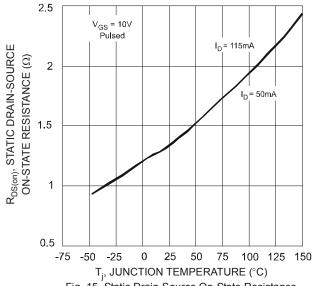




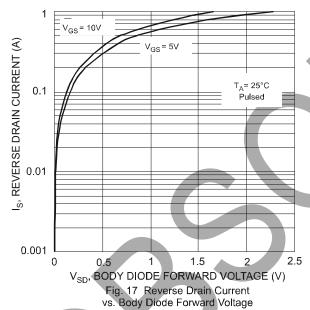
# **Typical N-Channel MOSFET (Q2) Characteristics**

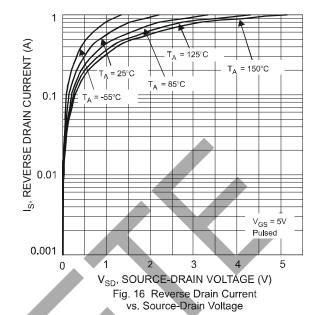












900 g<sub>FS</sub>, FORWARD TRANSCONDUCTANCE (mS) 800 T<sub>A</sub> = -55°C 700 600 500 400 T<sub>A</sub> = 125°C T<sub>A</sub>= 150°C 300 200 100 0 .2 0.4 0. I<sub>D</sub>, DRAIN CURRENT (A) 0.2 0 0.6 0.8 Fig. 18 Forward Transfer Conductance vs. Drain Current  $(V_{DS} > I_D R_{DS(ON)})$ 



### **Application Details**

PNP Transistor (DDTB142JU) and N-MOSFET (DSNM6047) with gate pull-down resistor integrated as one in LMN200B02 can be used as a discrete entity for general purpose applications or as an integrated circuit to function as a Load Switch. When it is used as the latter as shown in Fig 19, various input voltage sources can be used as long as it does not exceed the maximum ratings of the device. These devices are designed to deliver continuous output load current up to a maximum of 200 mA. The MOSFET Switch draws no current, hence loading of control circuit is prevented. Care must be taken for higher levels of dissipation while designing for higher load conditions. These devices provide high power and also consume less space. The product mainly helps in optimizing power usage, thereby conserving battery life in a controlled load system like portable battery powered applications. (Please see Fig. 20 for one example of a typical application circuit used in conjunction with voltage regulator as a part of a power management system)

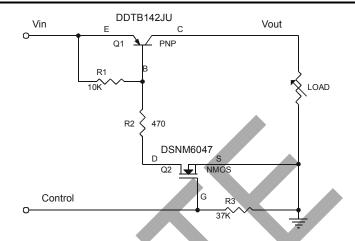


Fig. 19 Circuit Diagram

#### Typical Application Circuit

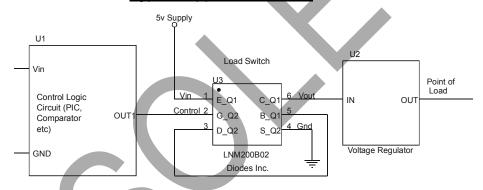


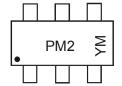
Fig. 20

# Ordering Information (Note 5)

Device	Packaging	Shipping
LMN200B02-7	SOT-363	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**



PM2 = Product Type Marking Code,

YM = Date Code Marking

Y = Year (ex: T = 2006)

M = Month (ex: 9 = September)

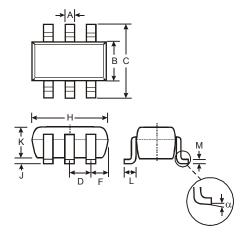
Date Code Key

Year	2006	2007	20	08	2009	2010	2011	2012	20	13	2014	2015
Code	T	U	'	/	W	Х	Υ	Z		4	В	С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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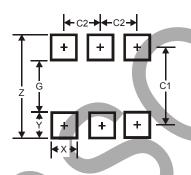


# **Mechanical Details**



	SOT-363				
Dim	Min	Max			
Α	0.10	0.30			
В	1.15	1.35			
С	2.00	2.20			
D	0.65	Тур			
F	0.40	0.45			
Н	1.80	2.20			
7	0	0.10			
K	0.90	1.00			
L	0.25	0.40			
М	0.10	0.22			
α	0°	8°			
All Di	mensions	in mm			

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Υ	0.6
C1	1.9
C2	0.65



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